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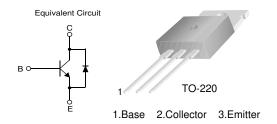


July 2008

# FJP5304D NPN Silicon Transistor

### **High Voltage High Speed Power Switch Application**

- · Wide Safe Operating Area
- Built-in Free Wheeling diodeSuitable for Electronic Ballast Application
- Suitable for Electronic Ballast Application
- · Small Variance in Storage Time



### Absolute Maximum Ratings T<sub>C</sub>=25°C unless otherwise noted

Symbol	Parameter	Value	Units	
V <sub>CBO</sub>	Collector-Base Voltage	700	V	
V <sub>CEO</sub>	Collector-Emitter Voltage	400	V	
V <sub>EBO</sub>	Emitter-Base Voltage	12	V	
I <sub>C</sub>	Collector Current (DC)	4	Α	
I <sub>CP</sub>	* Collector Current (Pulse)	8	Α	
I <sub>B</sub>	Base Current (DC)	2	Α	
I <sub>BP</sub>	* Base Current (Pulse)	4	Α	
P <sub>C</sub>	Collector Dissipation (T <sub>C</sub> =25°C)	70	W	
T <sub>STG</sub>	Storage Temperature	- 65 ~ 150	°C	

 $<sup>^{\</sup>star}$  Pulse Test Pulse Width = 5ms, Duty Cycle  $\geq 1.0\%$ 

## Electrical Characteristics T<sub>C</sub>=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
BV <sub>CBO</sub>	Collector-Base Breakdown Voltage	$I_{C} = 1 \text{mA}, I_{E} = 0$	700			V
BV <sub>CEO</sub>	Collector-Emitter Breakdown Voltage	$I_{C} = 5mA, I_{B} = 0$	400			V
BV <sub>EBO</sub>	Emitter-Base Breakdown Voltage	I <sub>E</sub> = 1mA, I <sub>C</sub> = 0	12			V
I <sub>CES</sub>	Collector Cut-off Current	V <sub>CE</sub> = 700V, V <sub>EB</sub> = 0			100	mA
I <sub>CEO</sub>	Collector Cut-off Current	V <sub>CE</sub> = 400V, IB = 0			250	mA
I <sub>EBO</sub>	Emitter Cut-off Current	V <sub>EB</sub> = 12V, I <sub>C</sub> = 0			100	mA

h <sub>FE</sub>	DC Current Gain	$V_{CE} = 5V, I_{C} = 10mA$ $V_{CE} = 5V, I_{C} = 2A$	10 8		40	
V <sub>CE</sub> (sat)	Collector-Emitter Saturation Voltage	$I_C = 0.5A, I_B = 0.1A$ $I_C = 1A, I_B = 0.2A$ $I_C = 2.5A, I_B = 0.5A$			0.7 1.0 1.5	V
V <sub>BE</sub> (sat)	Base-Emitter Saturation Voltage	$I_C = 0.5A, I_B = 0.1A$ $I_C = 1A, I_B = 0.2A$ $I_C = 2.5A, I_B = 0.5A$			1.1 1.2 1.3	V
V <sub>f</sub>	Internal Diode Forward Voltage Drop	I <sub>F</sub> = 2A			2.5	V
Inductive Lo	oad Switching (V <sub>CC</sub> = 200V)					
t <sub>stg</sub>	Storage Time	$I_C = 2A, I_{B1} = 0.4A$		0.6		μS
tf	Fall Time	$V_{BE}(off) = -5V, L = 200\mu H$		0.1		
Resistive Lo	oad Switching (V <sub>CC</sub> = 250V)					
t <sub>stg</sub>	Storage Time	$I_C = 2A$ , $I_{B1} = I_{B2} = 0.4A$			2.9	μS
tf	Fall Time	T <sub>P</sub> = 30μs		0.2		

<sup>\*</sup> Pulse test: PW $\leq$ 300 $\mu$ s, Duty cycle $\leq$ 2%

## **Thermal Characteristics**

Symbol	Parameter	Max.	Units
$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.78	°C/W
$R_{ heta JA}$	Thermal Resistance, Junction to Ambient	62.5	°C/W

## **Typical Characteristics**

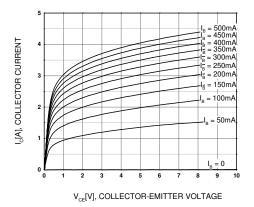


Figure 1. Static Characteristic

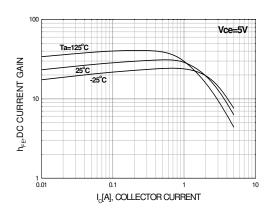


Figure 2. DC Current Gain

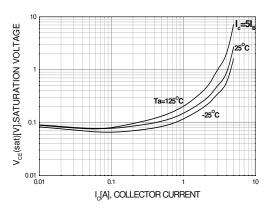


Figure 3. Collector-Emitter Saturation Voltage

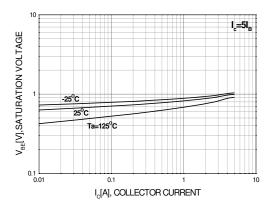


Figure 4. Base-Emitter Saturation Voltage

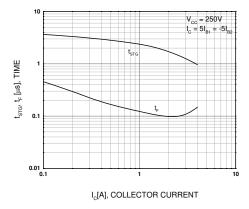


Figure 5. Resitive Load Switching Time

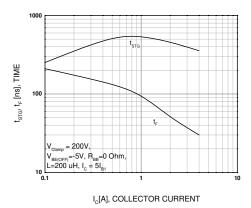


Figure 6. Inductive Load Switching Time

## Typical Characteristics (Continued)

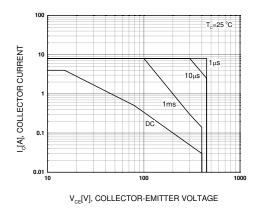


Figure 1. Forward Bias Safe Operating Area

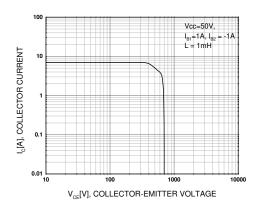


Figure 2. Reverse Bias Safe Operating Area

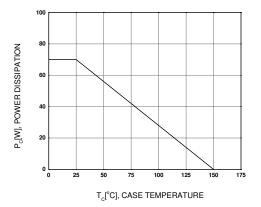
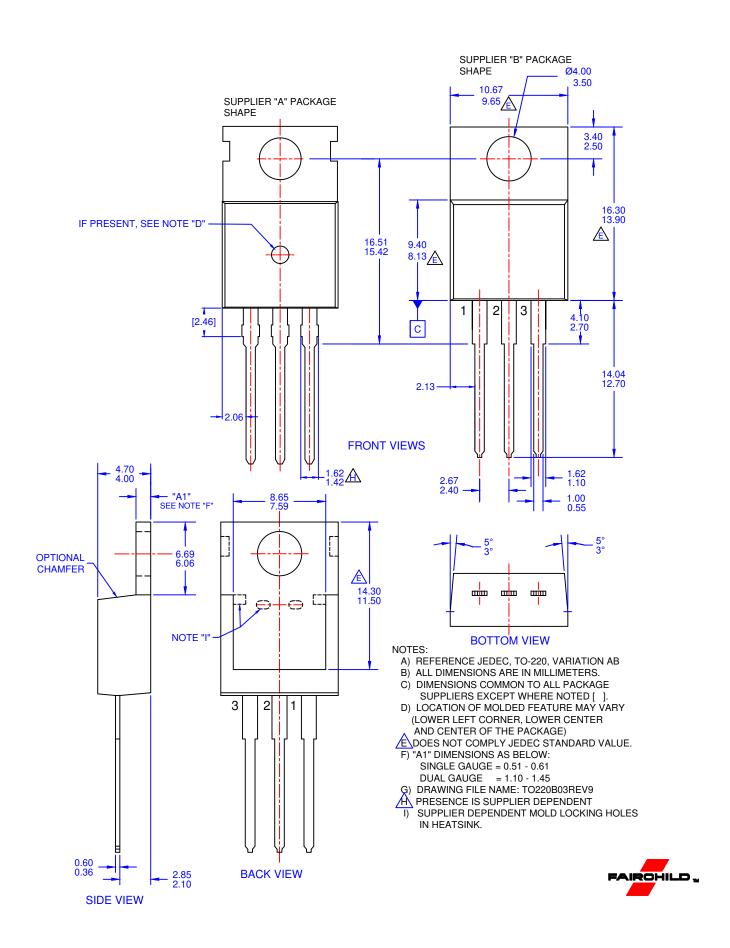


Figure 3. Power Derating



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